


APPLICATION DATA SHEET

Electronic Version v14

Stylesheet Version v14.0

Title of Invention	DOUBLE-SIDED MULTI-CHIP CIRCUIT COMPONENT		
Application Type : regular, utility Attorney Docket Number : DP-310085			
Correspondence address: Customer Number: 27127 			
Continuing Data: This is a Continuation-in-part of US application number 10/050,344, filed 2002-01-16 , now Pending.			
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as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.

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